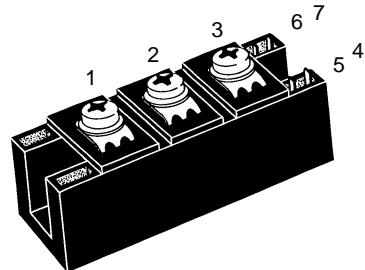
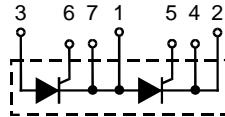


Thyristor Module

Preliminary data

V_{RSM}	V_{RRM}	Type
V_{DSM}	V_{DRM}	
V	V	
900	800	MCC 122-08io1
1300	1200	MCC 122-12io1
1500	1400	MCC 122-14io1
1700	1600	MCC 122-16io1
1900	1800	MCC 122-18io1



Symbol	Conditions	Maximum Ratings		
I_{TRMS}		300	A	
I_{TAVM}	$T_c = 85^\circ\text{C}$; 180° sine	128	A	
I_{TSM}	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0$	3600 3850	A A	
	$T_{VJ} = T_{VJM}$ $V_R = 0$	3200 3420	A A	
I^2dt	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0$	64800 62300	A^2s A^2s	
	$T_{VJ} = T_{VJM}$ $V_R = 0$	51200 49100	A^2s A^2s	
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}$ $f = 50\text{Hz}$, $t_p = 200\mu\text{s}$ $V_D = \frac{2}{3}V_{DRM}$ $I_G = 0.5\text{ A}$ $di_G/dt = 0.5\text{ A}/\mu\text{s}$	repetitive, $I_T = 500\text{ A}$ non repetitive, $I_T = 500\text{ A}$	150 500	$\text{A}/\mu\text{s}$ $\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}$; $V_{DR} = \frac{2}{3}V_{DRM}$ $R_{GK} = \infty$; method 1 (linear voltage rise)		1000	$\text{V}/\mu\text{s}$
P_{GM}	$T_{VJ} = T_{VJM}$ $I_T = I_{TAVM}$	$t_p = 30\mu\text{s}$ $t_p = 500\mu\text{s}$	120 60	W
P_{GAV}			8	W
V_{RGM}			10	V
T_{VJ}			-40...+125	$^\circ\text{C}$
T_{VJM}			125	$^\circ\text{C}$
T_{stg}			-40...+125	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1\text{ mA}$	$t = 1\text{ min}$ $t = 1\text{ s}$	3000 3600	V_\sim V_\sim
M_d	Mounting torque (M6) Terminal connection torque (M6)		2.25-2.75/20-25 Nm/lb.in. 4.5-5.5/40-48 Nm/lb.in.	
Weight	Typical including screws		125	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

$I_{TRMS} = 2 \times 300\text{ A}$
 $I_{TAVM} = 2 \times 128\text{ A}$
 $V_{RRM, DRM} = 800-1800\text{ V}$

Features

- International standard package
- Direct copper bonded Al_2O_3 -ceramic base plate
- Planar passivated chips
- Isolation voltage 3600 V \sim
- UL registered, E 72873
- Keyed gate/cathode twin pins

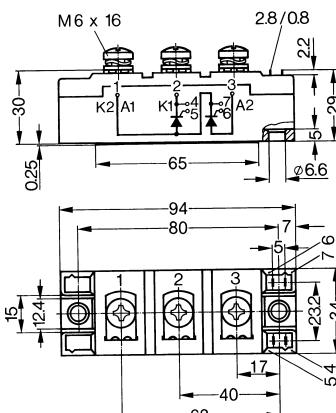
Applications

- Motor control
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Contactless switches

Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

Dimensions in mm (1 mm = 0.0394")



Symbol	Conditions	Characteristic Values		
I_{RRM}, I_{DRM}	$T_{VJ} = T_{VJM}; V_R = V_{RRM}; V_D = V_{DRM}$	10	mA	
V_T, V_F	$I_T, I_F = 120 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.13	V	
V_{TO}	$T_{VJ} = 125^\circ\text{C}$; For power-loss calculations only	0.85	V	
r_T	$T_{VJ} = T_{VJM}$	2	$\text{m}\Omega$	
V_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	1.4	V	
I_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	150	mA	
		200	mA	
V_{GD}	$T_{VJ} = T_{VJM}; V_D = \frac{2}{3} V_{DRM}$	0.2	V	
I_{GD}		10	mA	
I_L	$T_{VJ} = 25^\circ\text{C}; t_p = 10 \mu\text{s}, V_D = 6 \text{ V}$ $I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$	300	mA	
I_H	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	200	mA	
t_{gd}	$T_{VJ} = 25^\circ\text{C}; V_D = \frac{1}{2} V_{DRM}$ $I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$	2	μs	
t_q	$T_{VJ} = T_{VJM}; I_T = 120 \text{ A}, t_p = 200 \mu\text{s}; -di/dt = 10 \text{ A}/\mu\text{s typ.}$ $V_R = 100 \text{ V}; dv/dt = 20 \text{ V}/\mu\text{s}; V_D = \frac{2}{3} V_{DRM}$	150	μs	
Q_s	$T_{VJ} = T_{VJM}; I_T, I_F = 200 \text{ A}, -di/dt = 50 \text{ A}/\mu\text{s}$	330	μC	
I_{RM}		180	A	
R_{thJC}	per thyristor/diode; DC current	0.2	K/W	
	per module	0.1	K/W	
R_{thCH}	per thyristor/diode; DC current	typ.	0.1	K/W
d_s	Creepage distance on surface	12.7	mm	
d_A	Strike distance through air	9.6	mm	
a	Maximum allowable acceleration	50	m/s^2	

Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

Type **ZY 180L** (L = Left for pin pair 4/5) } UL Styles 1385,

Type **ZY 180R** (R = right for pin pair 6/7) } CSA Class 5851, File 41234